XC6219 Series

ETR0307_010

300mA High Speed LDO Regulators with ON/OFF Switch

■GENERAL DESCRIPTION

The XC6219 series are highly accurate, low noise, CMOS LDO Voltage Regulators. Offering low output noise, high ripple rejection ratio, low dropout and very fast turn-on times, the XC6219 series is ideal for today's cutting edge mobile phone.
Internally the XC6219/XC6211 includes a reference voltage source, error amplifiers, driver transistors, current limiters and phase compensators. The XC6219/XC6211's current limiters' foldback circuit also operates as a short protect for the output current limiter and. the output pin. The output voltage is set by laser trimming. Voltages are selectable in 50mV steps within a range of 0.9V to 5.0V. The XC6219 series is also fully compatible with low ESR ceramic capacitors, reducing cost and improving output stability. This high level of output stability is maintained even during frequent load fluctuations, due to the excellent transient response performance and high PSRR achieved across a broad range of frequencies.
The CE function allows the output of regulator to be turned off, resulting in greatly reduced power consumption.

■APPLICATIONS

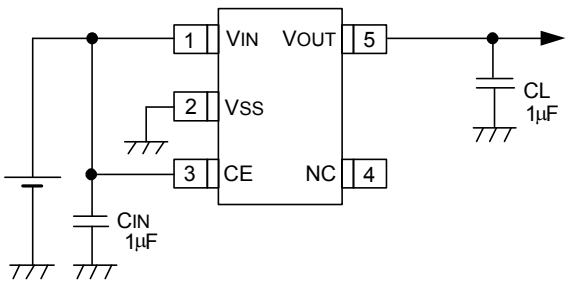
- ●Smart phones / Mobile phones
- ●Portable games
- ●Digital still cameras / Camcorders
- ●Reference voltage sources
- ●Multi-function power supplies

■FEATURES

Maximum Output Current	: 150mA (V_{OUT}<1.75V, A~D type) 240mA (V_{OUT}≧1.8V, A~D type) 300mA (V_{OUT}≧1.3V, E~H type)
Dropout Voltage	: 200mV @ 100mA
Operating Voltage Range	: 2.0V ~ 6.0V
Output Voltage Range	: 0.9V ~ 5.0V (0.05V steps)
Highly Accuracy	: ±2% (V_{OUT}>1.5V) ±30mV (V_{OUT}≦1.5V) ±1% (V_{OUT}≧3.0V)
Low Power Consumption	: 25μA (TYP.)
Standby Current	: Less than 0.1μA (TYP.)
High Ripple Rejection	: 65dB @10kHz
Operating Ambient Temperature	: -40℃ ~ 85℃
Low ESR Capacitor	: Ceramic capacitor compatible
Ultra Small Packages	: SOT-25 SOT-89-5 USP-6B
Environmentally Friendly	: EU RoHS Compliant, Pb Free

■TYPICAL APPLICATION CIRCUIT

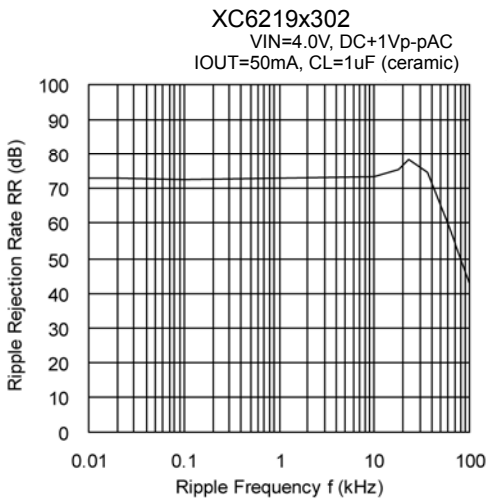
●XC6219 series



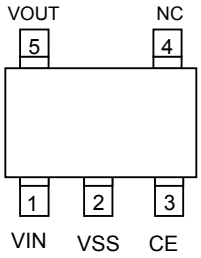
SOT-25

■TYPICAL PERFORMANCE CHARACTERISTICS

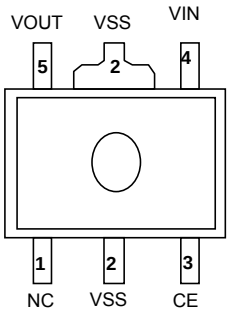
●Ripple Rejection Rate



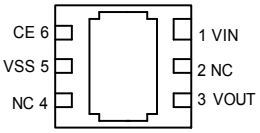
■PIN CONFIGURATION



SOT-25
(TOP VIEW)



SOT-89-5
(TOP VIEW)



USP-6B
(BOTTOM VIEW)

* The dissipation pad for the USP-6B package should be solder-plated in recommended mount pattern and metal masking so as to enhance mounting strength and hear release. If the pad needs to be connected to other pins, it should be connected to the VSS pin.

■PIN ASSIGNMENT

PIN NUMBER			PIN NAME	FUNCTIONS
SOT-25	SOT-89-5	USP-6B		
1	4	1	V_{IN}	Power Input
2	2	5	V_{SS}	Ground
3	3	6	CE	ON / OFF Control
4	1	2, 4	NC	No Connection
5	5	3	V_{OUT}	Output

■FUNCTION

TYPE A,E

PIN NAME	SIGNAL	STATUS
CE	L	Stand-by
	H	Active
	OPEN	Stand-by

TYPE B,F

PIN NAME	SIGNAL	STATUS
CE	L	Stand-by
	H	Active
	OPEN	Undefined state

TYPE C,G

PIN NAME	SIGNAL	STATUS
CE	L	Active
	H	Stand-by
	OPEN	Stand-by

TYPE D,H

PIN NAME	SIGNAL	STATUS
CE	L	Active
	H	Stand-by
	OPEN	Undefined state

*If XC6219 B,D,F,H types are used with the CE pin opened, the IC goes into “Undefined state”.
The CE pin voltage should be fixed in low or high for stable operation.

■PRODUCT CLASSIFICATION

●Ordering Information

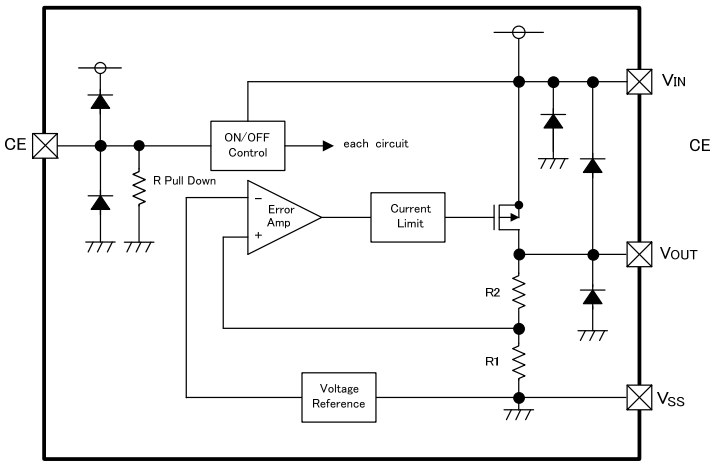
XC6219 ①②③④⑤⑥–⑦(*1)

DESIGNATOR	ITEM	SYMBOL	DESCRIPTION
①	CE Pin Logic	A	150mA, Active high, pull-down resistor built in (Semi-custom)
		B	150mA, Active high , no pull-down resistor built in (Standard)
		C	150mA, Active low, pull-up resistor built in (Semi-custom)
		D	150mA, Active low, no pull-up resistor built in (Semi-custom)
		E	300mA, Active high, pull-down resistor built in (Semi-custom)
		F	300mA, Active high, no pull-down resistor built in (Standard)
		G	300mA, Active low, pull-up resistor built in (Semi-custom)
		H	300mA, Active low, no pull-up resistor built in (Semi-custom)
②③	Output Voltage	09～50	e.g. ②=3, ③=0, → 3.0V
④	Output Voltage Accuracy	2(*3)	0.1V increments, ±2% accuracy e.g. ③=2, ③=8, ④=2 → 2.80V, ±2%
		1(*2)	0.1V increments, ±1% accuracy e.g. ②=3, ③=0, ④=1 → 3.00V, ±1%
		A(*3)	0.05V increments, ±2% accuracy e.g. ②=2, ③=8, ④=A → 2.85V, ±2%
		B(*2)	0.05V increments, ±1% accuracy e.g. ②=3, ③=0, ④=B → 3.05V, ±1%
⑤⑥-⑦	Packages (Order Unit)	MR-G	SOT-25 (3,000/Reel)
		PR-G	SOT-89-5 (1,000/Reel)
		DR-G	USP-6B (3,000/Reel)

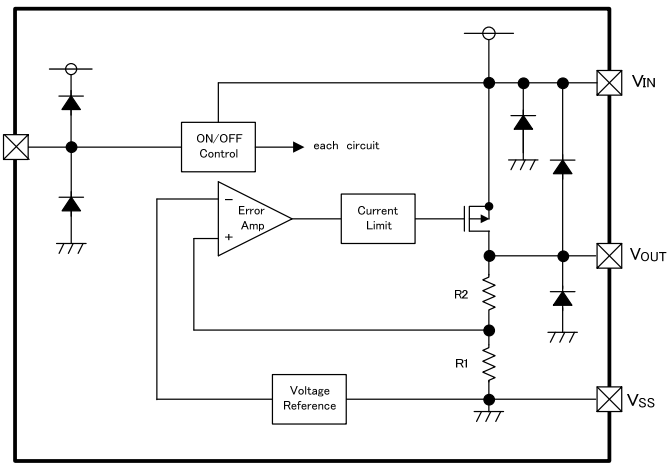
(*1) The “-G” suffix denotes Halogen and Antimony free as well as being fully EU RoHS compliant.
(*2) Output voltage of the ±1% accuracy product is 3.0V or more.
(*3) Output voltage accuracy of the $V_{OUT} \leqq 1.5V$ is ±30mV.

■BLOCK DIAGRAM

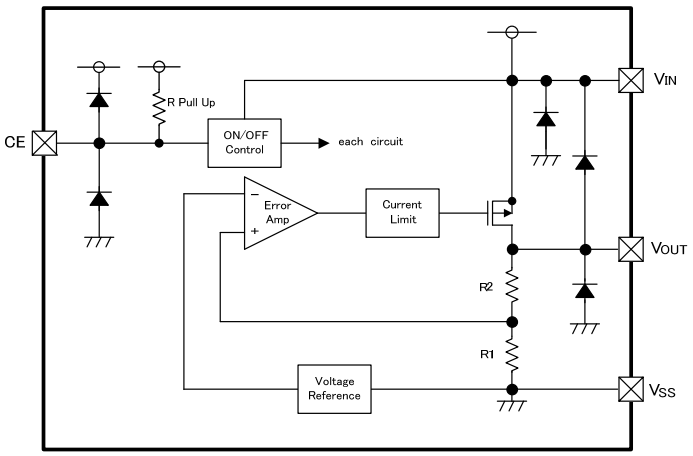
XC6219 series Type A,E



XC6219 series Type B,D,F,H



XC6219 series Type C,G



*Diode inside the circuit are an ESD protection diode and a parasitic diode.

■ABSOLUTE MAXIMUM RATINGS

Ta=25℃

PARAMETER		SYMBOL	RATINGS	UNITS
Input Voltage		V_{IN}	7	V
Output Current		I_{OUT}	500(*1)	mA
Output Voltage		V_{OUT}	V_{SS} - 0.3 ~ V_{IN} + 0.3	V
CE Pin Voltage		V_{CE}	V_{SS} - 0.3 ~ V_{IN} + 0.3	V
Power Dissipation	SOT-25	Pd	250	mW
			600 (PCB mounted)(*2)	
	SOT-89		500	
			1300 (PCB mounted)(*2)	
	USP-6B		120	
			1000 (PCB mounted)(*2)	
Operating Ambient Temperature		Topr	- 40 ~ + 85	℃
Storage Temperature		Tstg	- 55 ~ + 125	℃

All voltages are described based on the V_{SS} pin.

(*1) $I_{OUT} \leqq Pd/(V_{IN}-V_{OUT})$

(*2) The power dissipation figure shown is PCB mounted and is for reference only. Please refer to page 24~26 for details.

■ELECTRICAL CHARACTERISTICS

●XC6219 Type A,B

Ta=25℃

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUIT
Output Voltage (*5) (2%)	$V_{OUT(E)}$ (*3)	I_{OUT}=30mA	$V_{OUT(T)}$ (*2) ×0.98	$V_{OUT(T)}$ (*2)	$V_{OUT(T)}$ (*2) ×1.02	V	①
Output Voltage (*6) (1%)			$V_{OUT(T)}$ (*2) ×0.99	$V_{OUT(T)}$ (*2)	$V_{OUT(T)}$ (*2) ×1.01		
Maximum Output Current	I_{OUTMAX}	0.9V≦$V_{OUT(T)}$≦1.75V	150	-	-	mA	①
		1.8V≦$V_{OUT(T)}$≦5.0V	240	-	-		
Load Regulation	ΔV_{OUT}	1mA≦I_{OUT}≦100mA	-	15	50	mV	①
Dropout Voltage (*4)	Vdif1	I_{OUT}=30mA	-	E-1		mV	①
	Vdif2	I_{OUT}=100mA	-	E-2			
Supply Current (Type A)	I_{DD}	V_{CE}=V_{IN}=$V_{OUT(T)}$+1.0V V_{OUT}≦0.95V, V_{IN}=V_{CE}=2.0V	-	28	55	μA	②
Supply Current (Type B)			-	25	50		
Stand-by Current	I_{STB}	V_{IN}=$V_{OUT(T)}$+1.0V、V_{CE}=V_{SS} V_{OUT}≦0.95V, V_{IN}=2.0V	-	0.01	0.10	μA	②
Line Regulation	ΔV_{OUT}/ (ΔV_{IN}・V_{OUT})	$V_{OUT(T)}$+1.0V≦V_{IN}≦6.0V V_{OUT}≦0.95V, 2.0V≦V_{IN}≦6.0V I_{OUT}=30mA V_{OUT}≦1.75V, I_{OUT}=10mA	-	0.01	0.20	%/V	①
Input Voltage	V_{IN}	-	2	-	6	V	-
Output Voltage Temperature Characteristics	ΔV_{OUT}/ (ΔTopr・V_{OUT})	I_{OUT}=30mA -40℃≦Topr≦85℃	-	±100	-	ppm/℃	①
Power Supply Rejection Ratio	PSRR	V_{IN}=[$V_{OUT(T)}$+1.0]V+1.0Vp-p_{AC} V_{OUT}≦1.5, V_{IN}=2.5V+1.0Vp-p_{AC} I_{OUT}=50mA、f=10kHz	-	E-3	-	dB	④
Current Limiter	Ilim	V_{IN}=$V_{OUT(T)}$+2.0V、V_{CE}=V_{IN} 0.9V≦$V_{OUT(T)}$≦1.75V	-	300	-	mA	①
		V_{IN}=$V_{OUT(T)}$+1.0V、V_{CE}=V_{IN} 1.8V≦$V_{OUT(T)}$≦5.0V	240	300	-		
Short Circuit Current	I_{SHORT}	V_{IN}=$V_{OUT(T)}$+1.0V、V_{CE}=V_{IN} V_{OUT}≦1.75V, V_{IN}=$V_{OUT(T)}$+2.0V	-	50	-	mA	①
CE 'High' Level Voltage	V_{CEH}	-	1.6	-	V_{IN}	V	①
CE 'Low' Level Voltage	V_{CEL}	-	-	-	0.25	V	①
CE 'High' Level Current (Type A)	I_{CEH}	V_{IN}=V_{CE}=$V_{OUT(T)}$+1.0V V_{OUT}≦0.95V, V_{IN}=V_{CE}=2.0V	-0.10	-	5.0	μA	②
CE 'High' Level Current (Type B)			-0.10	-	0.10		
CE 'Low' Level Current	I_{CEL}	V_{IN}=$V_{OUT(T)}$+1.0V、V_{CE}=V_{SS} V_{OUT}≦0.95V, V_{IN}=2.0V	-0.10	-	0.10	μA	②

(*1) Unless otherwise stated, V_{IN}=$V_{OUT(T)}$+1.0V. If V_{OUT} is less than 0.95V, V_{IN}= 2.0V.

(*2) $V_{OUT(T)}$ = Specified output voltage

(*3) $V_{OUT(E)}$ = Effective output voltage

The output voltage when "$V_{OUT(T)}$+1.0V" is provided at the V_{IN} pin while maintaining a certain I_{OUT} value.

(*4) Vdif={V_{IN1}-V_{OUT1}}

V_{OUT1}=A voltage equal to 98% of the output voltage whenever an amply stabilized I_{OUT} {$V_{OUT(T)}$+1.0V} is input.

V_{IN1}=The Input Voltage when V_{OUT1} appears as Input Voltage is gradually decreased.

(*5) If $V_{OUT(T)}$ is less than 1.45V, $V_{OUT(T)}$ -30mV (MIN.), $V_{OUT(T)}$ + 30mV (MAX.)

(*6) Only for the $V_{OUT(T)}$ is more than 3.0V products.

■ELECTRICAL CHARACTERISTICS

●XC6219 Type C,D

Ta=25℃

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUIT
Output Voltage (*5) (2%)	$V_{OUT(E)}$ (*3)	I_{OUT}=30mA	$V_{OUT(T)}$ (*2) ×0.98	$V_{OUT(T)}$ (*2)	$V_{OUT(T)}$ (*2) ×1.02	V	①
Output Voltage (*6) (1%)			$V_{OUT(T)}$ (*2) ×0.99	$V_{OUT(T)}$ (*2)	$V_{OUT(T)}$ (*2) ×1.01		
Maximum Output Current	I_{OUTMAX}	0.9V≦$V_{OUT(T)}$≦1.75V	150	-	-	mA	①
		1.8V≦$V_{OUT(T)}$≦5.0V	240	-	-		
Load Regulation	ΔV_{OUT}	1mA≦I_{OUT}≦100mA	-	15	50	mV	①
Dropout Voltage (*4)	Vdif1	I_{OUT}=30mA	-	E-1		mV	①
	Vdif2	I_{OUT}=100mA	-	E-2			
Supply Current (Type C)	I_{DD}	V_{IN}=$V_{OUT(T)}$+1.0V V_{OUT}≦0.95V, V_{IN}=2.0V V_{CE}=V_{SS}	-	28	55	μA	②
Supply Current (Type D)			-	25	50		
Stand-by Current	I_{STB}	V_{IN}=$V_{OUT(T)}$+1.0V、V_{CE}=V_{IN} V_{OUT}≦0.95V, V_{IN}=V_{CE}=2.0V	-	0.01	0.10	μA	②
Line Regulation	ΔV_{OUT}/ (ΔV_{IN}・V_{OUT})	$V_{OUT(T)}$+1.0V≦V_{IN}≦6.0V V_{OUT}≦0.95V, 2.0V≦V_{IN}≦6.0V I_{OUT}=30mA V_{OUT}≦1.75V, I_{OUT}=10mA	-	0.01	0.20	%/V	①
Input Voltage	V_{IN}	-	2	-	6	V	-
Output Voltage Temperature Characteristics	ΔV_{OUT}/ (ΔTopr・V_{OUT})	I_{OUT}=30mA -40℃≦Topr≦85℃	-	±100	-	ppm/℃	①
Power Supply Rejection Ratio	PSRR	V_{IN}=[$V_{OUT(T)}$+1.0]V+1.0Vp-p_{AC} V_{OUT}≦1.5, V_{IN}=2.5V+1.0Vp-p_{AC} I_{OUT}=50mA、f=10kHz	-	E-3	-	dB	④
Current Limiter	Ilim	V_{IN}=$V_{OUT(T)}$+2.0V、V_{CE}=V_{SS} 0.9V≦$V_{OUT(T)}$≦1.75V	-	300	-	mA	①
		V_{IN}=$V_{OUT(T)}$+1.0V、V_{CE}=V_{SS} 1.8V≦$V_{OUT(T)}$≦5.0V	240	300	-		
Short Circuit Current	I_{SHORT}	V_{IN}=$V_{OUT(T)}$+1.0V、V_{CE}=V_{IN} V_{OUT}≦1.75V, V_{IN}=$V_{OUT(T)}$+2.0V	-	50	-	mA	①
CE 'High' Level Voltage	V_{CEH}	-	1.6	-	V_{IN}	V	①
CE 'Low' Level Voltage	V_{CEL}	-	-	-	0.25	V	①
CE 'High' Level Current	I_{CEH}	V_{CE}=V_{IN}=$V_{OUT(T)}$+1.0V V_{OUT}≦0.95V, V_{CE}=V_{IN}=2.0V	-0.10	-	0.10	μA	②
CE 'Low' Level Current (Type C)	I_{CEL}	V_{IN}=$V_{OUT(T)}$+1.0V,V_{CE}=V_{SS} V_{OUT}≦0.95V, V_{IN}=2.0V	-5.0	-	0.10	μA	②
CE 'Low' Level Current (Type D)			-0.10	-	0.10		

(*1) Unless otherwise stated, V_{IN}=$V_{OUT(T)}$+1.0V. If V_{OUT} is less than 0.95V, V_{IN}= 2.0V.

(*2) $V_{OUT(T)}$ = Specified output voltage

(*3) $V_{OUT(E)}$ = Effective output voltage

The output voltage when "$V_{OUT(T)}$+1.0V" is provided at the V_{IN} pin while maintaining a certain I_{OUT} value.

(*4) Vdif={V_{IN1}-V_{OUT1}}

V_{OUT1}=A voltage equal to 98% of the output voltage whenever an amply stabilized I_{OUT} {$V_{OUT(T)}$+1.0V} is input.

V_{IN1}=The Input Voltage when V_{OUT1} appears as Input Voltage is gradually decreased.

(*5) If $V_{OUT(T)}$ is less than 1.45V, $V_{OUT(T)}$ -30mV (MIN.), $V_{OUT(T)}$ + 30mV (MAX.)

(*6) Only for the $V_{OUT(T)}$ is more than 3.0V products.

■ELECTRICAL CHARACTERISTICS

●XC6219 Type E,F

Ta=25℃

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUIT
Output Voltage (*5) (2%)	$V_{OUT(E)}$ (*3)	I_{OUT}=30mA	$V_{OUT(T)}$ (*2) ×0.98	$V_{OUT(T)}$ (*2)	$V_{OUT(T)}$ (*2) ×1.02	V	①
Output Voltage (*6) (1%)			$V_{OUT(T)}$ (*2) ×0.99	$V_{OUT(T)}$ (*2)	$V_{OUT(T)}$ (*2) ×1.01		
Maximum Output Current	I_{OUTMAX}	V_{IN}=E-5 (*7)	E-4	-	-	mA	①
Load Regulation	ΔV_{OUT}	1mA≦I_{OUT}≦100mA	-	15	50	mV	①
Load Regulation2	ΔV_{OUT2}	1mA≦I_{OUT}≦300mA	-	-	100	mV	①
Dropout Voltage (*4)	Vdif1	I_{OUT}=30mA	-	E-1		mV	①
	Vdif2	I_{OUT}=100mA	-	E-2			
Supply Current (Type E)	I_{DD}	V_{CE}=V_{IN}=$V_{OUT(T)}$+1.0V V_{OUT}≦0.95V, V_{CE}=V_{IN}=2.0V	-	28	55	μA	②
Supply Current (Type F)			-	25	50		
Stand-by Current	I_{STB}	V_{IN}=$V_{OUT(T)}$+1.0V、V_{CE}=V_{SS} V_{OUT}≦0.95V, V_{CE}=V_{IN}=2.0V	-	0.01	0.10	μA	②
Line Regulation	ΔV_{OUT}/ (ΔV_{IN}・V_{OUT})	$V_{OUT(T)}$+1.0V≦V_{IN}≦6.0V V_{OUT}≦0.95V, 2.0V≦V_{IN}≦6.0V I_{OUT}=30mA V_{OUT}≦1.75V, I_{OUT}=10mA	-	0.01	0.20	%/V	①
Input Voltage	V_{IN}	-	2	-	6	V	-
Output Voltage Temperature Characteristics	ΔV_{OUT}/ (ΔTopr・V_{OUT})	I_{OUT}=30mA -40℃≦Topr≦85℃	-	±100	-	ppm/℃	①
Power Supply Rejection Ratio	PSRR	V_{IN}=[$V_{OUT(T)}$+1.0]V+1.0Vp-p_{AC} V_{OUT}≦1.5, V_{IN}=2.5V+1.0Vp-p_{AC} I_{OUT}=50mA、f=10kHz	-	70	-	dB	④
Current Limiter	Ilim	V_{IN}=$V_{OUT(T)}$+2.0V、V_{CE}=V_{IN} 0.9V≦$V_{OUT(T)}$≦1.75V	-	380	-	mA	①
		V_{IN}=$V_{OUT(T)}$+1.0V、V_{CE}=V_{IN} 1.8V≦$V_{OUT(T)}$≦5.0V					
Short Circuit Current	I_{SHORT}	V_{IN}=$V_{OUT(T)}$+1.0V、V_{CE}=V_{IN} V_{OUT}≦1.75V, V_{IN}=$V_{OUT(T)}$+2.0V	-	50	-	mA	①
CE 'High' Level Voltage	V_{CEH}	-	1.6	-	V_{IN}	V	①
CE 'Low' Level Voltage	V_{CEL}	-	-	-	0.25	V	①
CE 'High' Level Current (Type E)	I_{CEH}	V_{IN}=V_{CE}=$V_{OUT(T)}$+1.0V V_{OUT}≦0.95V, V_{IN}=V_{CE}=2.0V	-0.10	-	5.0	μA	②
CE 'High' Level Current (Type F)			-0.10	-	0.10		
CE 'Low' Level Current	I_{CEL}	V_{IN}=$V_{OUT(T)}$+1.0V、V_{CE}=V_{SS} V_{OUT}≦0.95V, V_{IN}=2.0V	-0.1	-	0.1	μA	②

(*1) Unless otherwise stated, V_{IN}=$V_{OUT(T)}$+1.0V. If V_{OUT} is less than 0.95V, V_{IN}= 2.0V.

(*2) $V_{OUT(T)}$ = Specified output voltage

(*3) $V_{OUT(E)}$ = Effective output voltage

The output voltage when "$V_{OUT(T)}$+1.0V" is provided at the V_{IN} pin while maintaining a certain I_{OUT} value.

(*4) Vdif={V_{IN1}-V_{OUT1}}

V_{OUT1}=A voltage equal to 98% of the output voltage whenever an amply stabilized I_{OUT} {$V_{OUT(T)}$+1.0V} is input.

V_{IN1}=The Input Voltage when V_{OUT1} appears as Input Voltage is gradually decreased.

(*5) If $V_{OUT(T)}$ is less than 1.45V, $V_{OUT(T)}$ -30mV (MIN.), $V_{OUT(T)}$ + 30mV (MAX.)

(*6) Only for the $V_{OUT(T)}$ is more than 3.0V products.

(*7) Please refer to the "Voltage Chart" table.

■ELECTRICAL CHARACTERISTICS

●XC6219 Type G,H

Ta=25℃

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUIT
Output Voltage (*5) (2%)	$V_{OUT(E)}$ (*3)	I_{OUT}=30mA	$V_{OUT(T)}$ (*2) ×0.98	$V_{OUT(T)}$ (*2)	$V_{OUT(T)}$ (*2) ×1.02	V	①
Output Voltage (*6) (1%)			$V_{OUT(T)}$ (*2) ×0.99	$V_{OUT(T)}$ (*2)	$V_{OUT(T)}$ (*2) ×1.01		
Maximum Output Current	I_{OUTMAX}	V_{IN}=E-5 (*7)	E-4	-	-	mA	①
Load Regulation	ΔV_{OUT}	1mA≦I_{OUT}≦100mA	-	15	50	mV	①
Load Regulation2	ΔV_{OUT2}	1mA≦I_{OUT}≦300mA	-	-	100	mV	①
Dropout Voltage (*4)	Vdif1	I_{OUT}=30mA	-	E-1		mV	①
	Vdif2	I_{OUT}=100mA	-	E-2			
Supply Current (Type G)	I_{DD}	V_{CE}=V_{IN}=$V_{OUT(T)}$+1.0V V_{OUT}≦0.95V, V_{IN}=2.0V V_{CE}=V_{SS}	-	28	55	μA	②
Supply Current (Type H)			-	25	50		
Stand-by Current	I_{STB}	V_{IN}=$V_{OUT(T)}$+1.0V、V_{CE}=V_{IN} V_{OUT}≦0.95V, V_{CE}=V_{IN}=2.0V	-	0.01	0.10	μA	②
Line Regulation	ΔV_{OUT}/ (ΔV_{IN}・V_{OUT})	$V_{OUT(T)}$+1.0V≦V_{IN}≦6.0V V_{OUT}≦0.95V, 2.0V≦V_{IN}≦6.0V I_{OUT}=30mA V_{OUT}≦1.75V, I_{OUT}=10mA	-	0.01	0.20	%/V	①
Input Voltage	V_{IN}	-	2	-	6	V	-
Output Voltage Temperature Characteristics	ΔV_{OUT}/ (ΔTopr・V_{OUT})	I_{OUT}=30mA -40℃≦Topr≦85℃	-	±100	-	ppm/℃	①
Power Supply Rejection Ratio	PSRR	V_{IN}=[$V_{OUT(T)}$+1.0]V+1.0Vp-p_{AC} V_{OUT}≦1.5, V_{IN}=2.5V+1.0Vp-p_{AC} I_{OUT}=50mA、f=10kHz	-	70	-	dB	④
Current Limiter	Ilim	V_{IN}=$V_{OUT(T)}$+2.0V、V_{CE}=V_{SS} 0.9V≦$V_{OUT(T)}$≦1.75V	-	380	-	mA	①
		V_{IN}=$V_{OUT(T)}$+1.0V、V_{CE}=V_{SS} 1.8V≦$V_{OUT(T)}$≦5.0V					
Short Circuit Current	I_{SHORT}	V_{IN}=$V_{OUT(T)}$+1.0V、V_{CE}=V_{ss} V_{OUT}≦1.75V, V_{IN}=$V_{OUT(T)}$+2.0V	-	50	-	mA	①
CE 'High' Level Voltage	V_{CEH}	-	1.6	-	V_{IN}	V	①
CE 'Low' Level Voltage	V_{CEL}	-	-	-	0.25	V	①
CE 'High' Level Current	I_{CEH}	V_{CE}=V_{IN}=$V_{OUT(T)}$+1.0V V_{OUT}≦0.95V, V_{CE}=V_{IN}=2.0V	-0.10	-	0.10	μA	②
CE 'Low' Level Current (Type G)	I_{CEL}	V_{IN}=$V_{OUT(T)}$+1.0V、V_{CE}=V_{SS} V_{OUT}≦0.95V, V_{IN}=2.0V	-5.0	-	0.10	μA	②
CE 'Low' Level Current (Type H)			-0.10	-	0.10		

(*1) Unless otherwise stated, V_{IN}=$V_{OUT(T)}$+1.0V. If V_{OUT} is less than 0.95V, V_{IN}= 2.0V.

(*2) $V_{OUT(T)}$ = Specified output voltage

(*3) $V_{OUT(E)}$ = Effective output voltage

The output voltage when "$V_{OUT(T)}$+1.0V" is provided at the V_{IN} pin while maintaining a certain I_{OUT} value.

(*4) Vdif={V_{IN1}-V_{OUT1}}

V_{OUT1}=A voltage equal to 98% of the output voltage whenever an amply stabilized I_{OUT} {$V_{OUT(T)}$+1.0V} is input.

V_{IN1}=The Input Voltage when V_{OUT1} appears as Input Voltage is gradually decreased.

(*5) If $V_{OUT(T)}$ is less than 1.45V, $V_{OUT(T)}$ -30mV (MIN.), $V_{OUT(T)}$ + 30mV (MAX.)

(*6) Only for the $V_{OUT(T)}$ is more than 3.0V products.

(*7) Please refer to the "Voltage Chart" table.

■ELECTRICAL CHARACTERISTICS (Continued)

●Voltage Chart

SYMBOL	E-0				E-1		E-2		E-3
PARAMETER / OUTPUT VOLTAGE	OUTPUT VOLTAGE (2%) (V)		OUTPUT VOLTAGE (1%) (V)		DROPOUT VOLTAGE1 (mV) (I_{OUT}=30mA)		DROPOUT VOLTAGE2 (mV) (I_{OUT}=100mA)		Power Supply Rejection Ratio
					Ta=25℃		Ta=25℃		Ta=25℃
$V_{OUT(T)}$	V_{OUT}		V_{OUT}		Vdif1		Vdif2		PSRR
	MIN	MAX	MIN	MAX	TYP	MAX	TYP	MAX	TYP
0.90	0.870	0.930	-	-	1100	1110	1150	1200	65
0.95	0.920	0.980	-	-					
1.00	0.970	1.030	-	-	1000	1010	1050	1100	
1.05	1.020	1.080	-	-					
1.10	1.070	1.130	-	-	900	910	950	1000	
1.15	1.120	1.180	-	-					
1.20	1.170	1.230	-	-	800	810	850	900	
1.25	1.220	1.280	-	-					
1.30	1.270	1.330	-	-	700	710	750	800	
1.35	1.320	1.380	-	-					
1.40	1.370	1.430	-	-	600	610	650	700	
1.45	1.420	1.480	-	-					
1.50	1.470	1.530	-	-	500	510	550	600	
1.55	1.519	1.581	-	-					
1.60	1.568	1.632	-	-	400	410	500	550	
1.65	1.617	1.683	-	-					
1.70	1.666	1.734	-	-	300	310	400	450	
1.75	1.715	1.785	-	-					
1.80	1.764	1.836	-	-	200	210	300	400	70
1.85	1.813	1.887	-	-					
1.90	1.862	1.938	-	-	120	150	280	380	
1.95	1.911	1.989	-	-					
2.00	1.960	2.040	-	-	80	120	240	350	
2.05	2.009	2.091	-	-					
2.10	2.058	2.142	-	-				330	
2.15	2.107	2.193	-	-					
2.20	2.156	2.244	-	-					
2.25	2.205	2.295	-	-					
2.30	2.254	2.346	-	-				310	
2.35	2.303	2.397	-	-					
2.40	2.352	2.448	-	-					
2.45	2.401	2.499	-	-					
2.50	2.450	2.550	-	-	70	100	220	290	
2.55	2.499	2.601	-	-					
2.60	2.548	2.652	-	-					
2.65	2.597	2.703	-	-					
2.70	2.646	2.754	-	-					
2.75	2.695	2.805	-	-					
2.80	2.744	2.856	-	-				270	
2.85	2.793	2.907	-	-					
2.90	2.842	2.958	-	-					
2.95	2.891	3.009	-	-					

■ELECTRICAL CHARACTERISTICS (Continued)

●Voltage Chart

SYMBOL	E-0				E-1		E-2		E-3
PARAMETER / OUTPUT VOLTAGE	OUTPUT VOLTAGE (2%) (V)		OUTPUT VOLTAGE (1%) (V)		DROPOUT VOLTAGE1 (mV) (I_{OUT}=30mA)		DROPOUT VOLTAGE2 (mV) (I_{OUT}=100mA)		Power Supply Rejection Ratio
					Ta=25℃		Ta=25℃		Ta=25℃
$V_{OUT(T)}$	V_{OUT}		V_{OUT}		Vdif1		Vdif2		PSRR
	MIN	MAX	MIN	MAX	TYP	MAX	TYP	MAX	TYP
3.00	2.940	3.060	2.970	3.030	60	90	200	270	70
3.05	2.989	3.111	3.020	3.081					
3.10	3.038	3.162	3.069	3.131				250	
3.15	3.087	3.213	3.119	3.182					
3.20	3.136	3.264	3.168	3.232					
3.25	3.185	3.315	3.218	3.283					
3.30	3.234	3.366	3.267	3.333					
3.35	3.283	3.417	3.317	3.384					
3.40	3.332	3.468	3.366	3.434					
3.45	3.381	3.519	3.416	3.485					
3.50	3.430	3.570	3.465	3.535					
3.55	3.479	3.621	3.515	3.586					
3.60	3.528	3.672	3.564	3.636					
3.65	3.577	3.723	3.614	3.687					
3.70	3.626	3.774	3.663	3.737					
3.75	3.675	3.825	3.713	3.788					
3.80	3.724	3.876	3.762	3.838					
3.85	3.773	3.927	3.812	3.889					
3.90	3.822	3.978	3.861	3.939					
3.95	3.871	4.029	3.911	3.990					
4.00	3.920	4.080	3.960	4.040		80	180	230	
4.05	3.969	4.131	4.010	4.091					
4.10	4.018	4.182	4.059	4.141					
4.15	4.067	4.233	4.109	4.192					
4.20	4.116	4.284	4.158	4.242					
4.25	4.165	4.335	4.208	4.293					
4.30	4.214	4.386	4.257	4.343					
4.35	4.263	4.437	4.307	4.394					
4.40	4.312	4.488	4.356	4.444					
4.45	4.361	4.539	4.405	4.494					
4.50	4.410	4.590	4.455	4.545					
4.55	4.459	4.641	4.504	4.595					
4.60	4.508	4.692	4.554	4.646					
4.65	4.557	4.743	4.603	4.696					
4.70	4.606	4.794	4.653	4.747					
4.75	4.655	4.845	4.702	4.797					
4.80	4.704	4.896	4.752	4.848					
4.85	4.753	4.947	4.801	4.898					
4.90	4.802	4.998	4.851	4.949					
4.95	4.851	5.049	4.900	4.999					
5.00	4.900	5.100	4.950	5.050	50	70	160	210	

■ELECTRICAL CHARACTERISTICS (Continued)

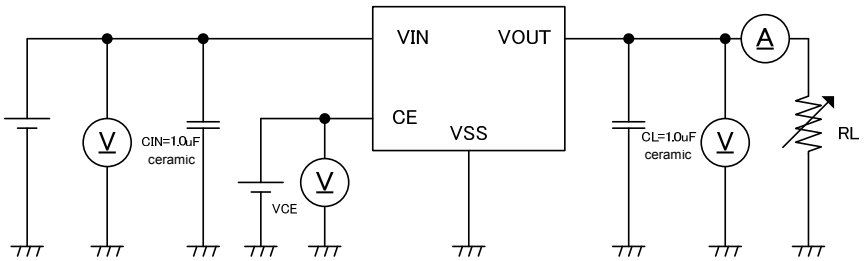
●Specification & Condition by Series

SYMBOL	E-5	E-4
CONDITION, RATINGS / OUTPUT VOLTAGE (V)	INPUT VOLTAGE (V)	MAX. OUTPUT CURRENT (mA)
	V_{IN}	MIN
0.90～0.95	2.5	260
1.00～1.05	2.5	260
1.10～1.15	2.6	270
1.20～1.25	2.7	290
1.30～1.35	2.8	300
1.40～1.45	2.9	
1.50～1.95	3.0	
2.00～6.00	$V_{OUT(T)}$+1.0	

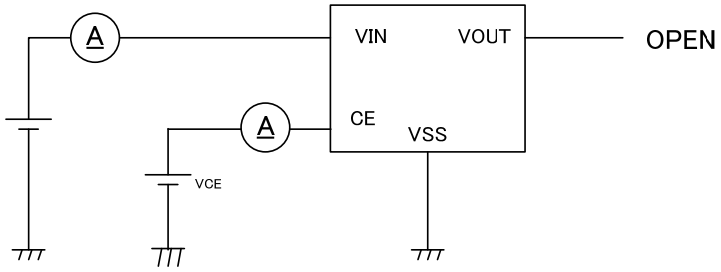
* $V_{OUT(T)}$=Nominal output voltage

■TEST CIRCUITS

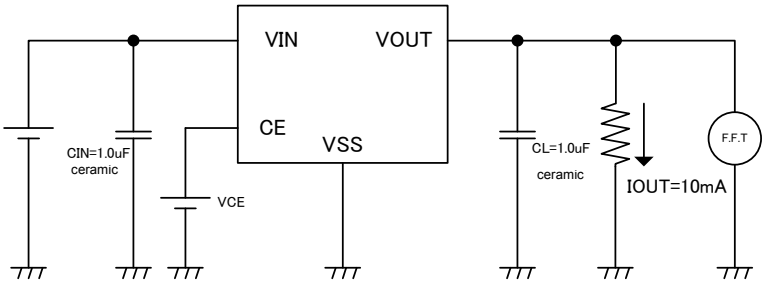
Circuit ①



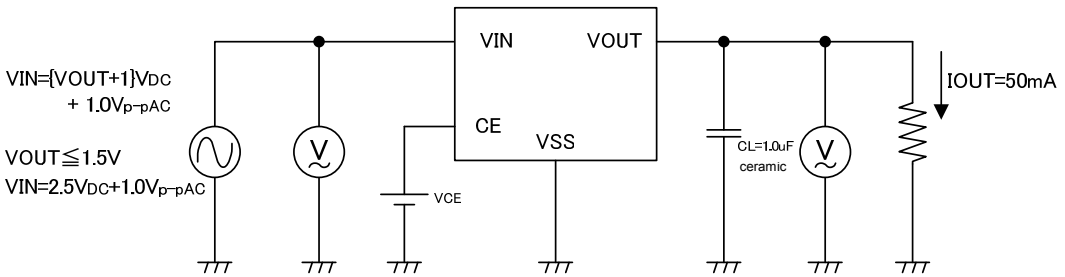
Circuit ②



Circuit ③



Circuit ④



*TEST CIRCUIT V_{CE} (CE Pin Voltage)

ACTIVE

XC6219 Type A,B,E,F: $V_{CE}=V_{IN}$

XC6219 Type C,D,G,H: $V_{CE}=V_{SS}$

STANDBY

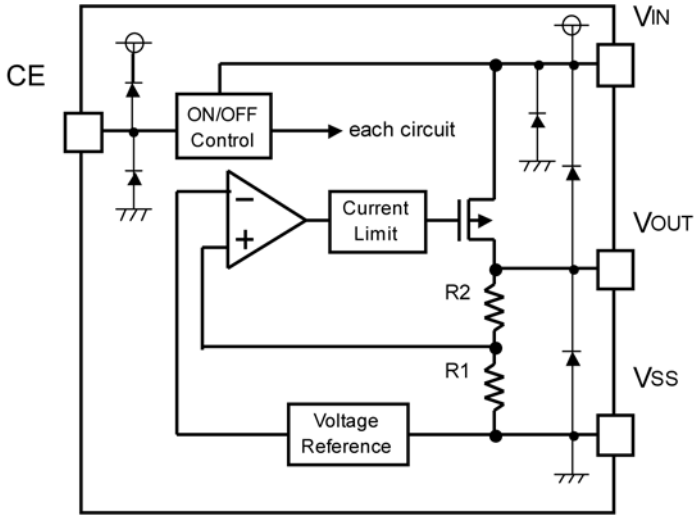
XC6219 Type A,B,E,F: $V_{CE}=V_{SS}$

XC6219 Type C,D,G,H: $V_{CE}=V_{IN}$

■OPERATIONAL EXPLANATION

<Output Voltage Control>

The voltage divided by resistors R1 & R2 is compared with the internal reference voltage by the error amplifier. The P-channel MOSFET, which is connected to the VOUT pin, is then driven by the subsequent output signal. The output voltage at the VOUT pin is controlled and stabilized by a system of negative feedback. The current limit circuit and short protect circuit operate in relation to the level of output current. Further, the IC's internal circuitry can be shutdown via the CE pin's signal



<Low ESR Capacitors>

With the XC6219 series, a stable output voltage is achievable even if used with low ESR capacitors as a phase compensation circuit is built-in. In order to ensure the effectiveness of the phase compensation, we suggest that an output capacitor (C_L) is connected as close as possible to the output pin (VOUT) and the VSS pin. Please use an output capacitor with a capacitance value of at least 1.0μF. Also, please connect an input capacitor (C_{IN}) of 1.0μF between the VIN pin and the VSS pin in order to ensure a stable power input.

Stable phase compensation may not be ensured if the capacitor runs out capacitance when depending on bias and temperature. In case the capacitor depends on the bias and temperature, please make sure the capacitor can ensure the actual capacitance.

<Current Limiter, Short-Circuit Protection>

The XC6219 series includes a combination of a fixed current limiter circuit & a foldback circuit, which aid the operations of the current limiter and circuit protection. When the load current reaches the current limit level, the fixed current limiter circuit operates and output voltage drops. As a result of this drop in output voltage, the foldback circuit operates, output voltage drops further and output current decreases. When the output pin is shorted, a current of about 50mA flows.

<CE Pin>

The IC's internal circuitry can be shutdown via the signal from the CE pin with the XC6219 series. In shutdown mode, output at the VOUT pin will be pulled down to the VSS level via R1 & R2. The operational logic of the IC's CE pin is selectable (please refer to the selection guide). Note that as the standard XC6219B type's regulator 1 and 2 are both ' High Active/No Pull-Down', operations will become unstable with the CE pin open. Although the CE pin is equal to an inverter input with CMOS hysteresis, with either the pull-up or pull-down options, the CE pin input current will increase when the IC is in operation. We suggest that you use this IC with either a VIN voltage or a VSS voltage input at the CE pin. If this IC is used with the correct specifications for the CE pin, the operational logic is fixed and the IC will operate normally. However, supply current may increase as a result of through current in the IC's internal circuitry.

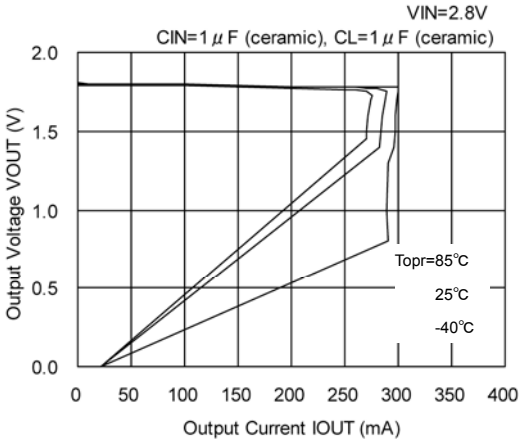
■NOTES ON USE

1. For temporary, transitional voltage drop or voltage rising phenomenon, the IC is liable to malfunction should the ratings be exceeded.
2. Where wiring impedance is high, operations may become unstable due to noise and/or phase lag depending on output current. Please keep the resistance low between V_{IN} and V_{SS} wiring in particular.
3. Please wire the input capacitor (C_{IN}) and the output capacitor (C_L) as close to the IC as possible.
4. The IC is controlled with constant current start-up. Start-up sequence control is requested to draw a load current after even nominal output voltage rising up the output voltage.
5. Torex places an importance on improving our products and their reliability.
   We request that users incorporate fail-safe designs and post-aging protection treatment when using Torex products in their systems.

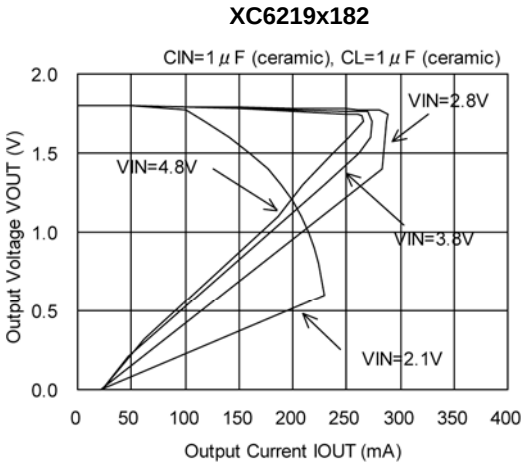
■TYPICAL PERFORMANCE CHARACTERISTICS

(1) Output Voltage vs. Output Current

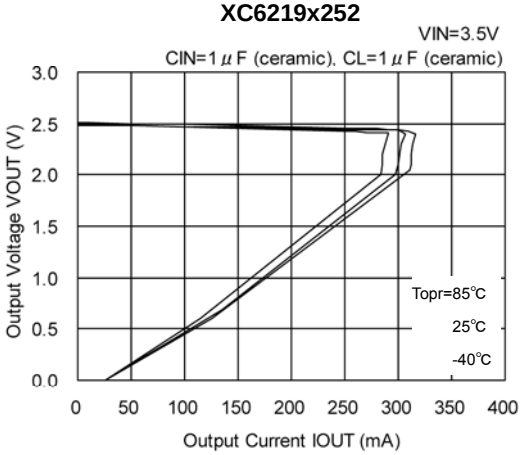
XC6219x182



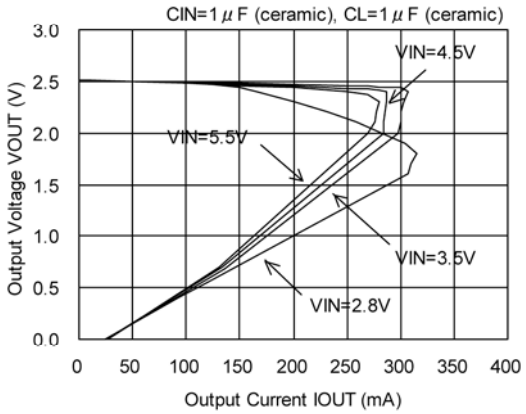
XC6219x182



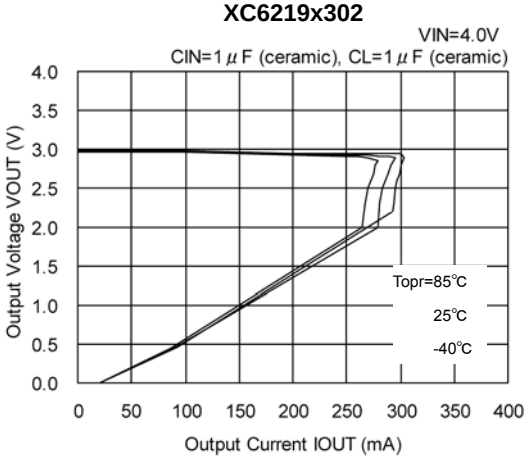
XC6219x252



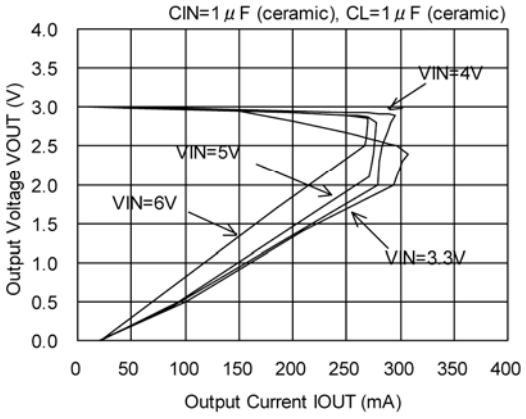
XC6219x252



XC6219x302



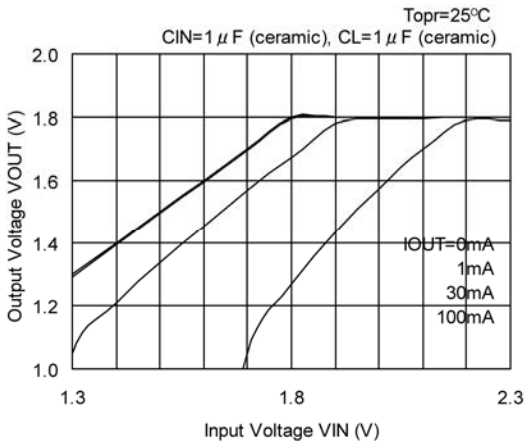
XC6219x302



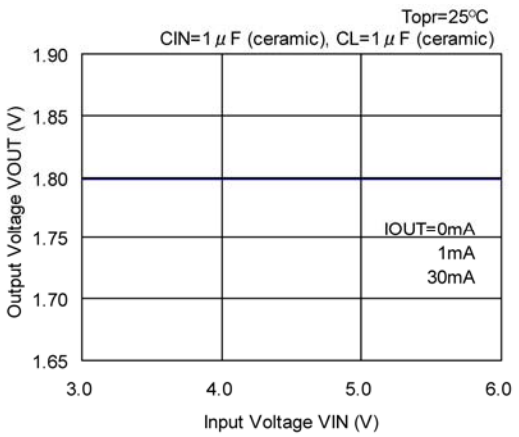
■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(2) Output Voltage vs. Input Voltage

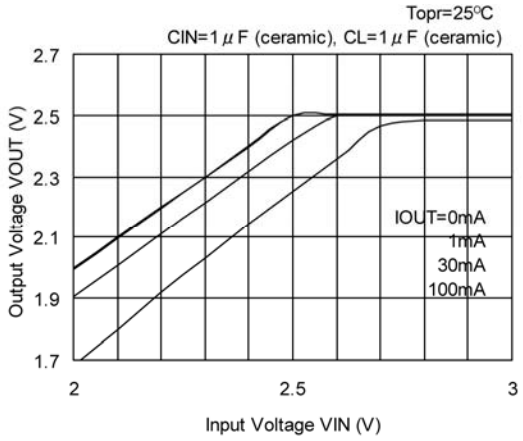
XC6219x182



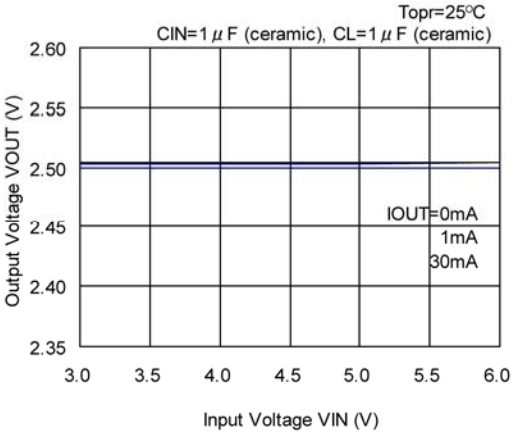
XC6219x182



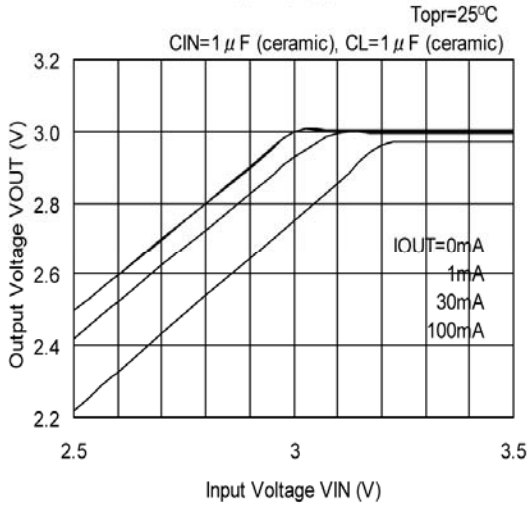
XC6219x252



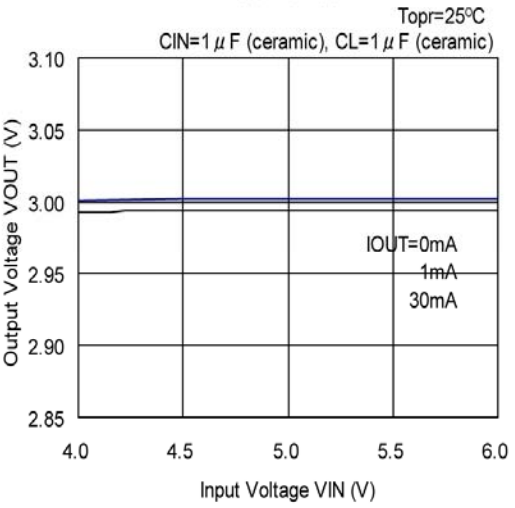
XC6219x252



XC6219x302



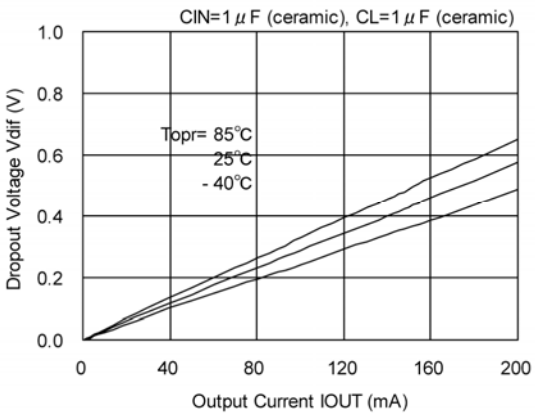
XC6219x302



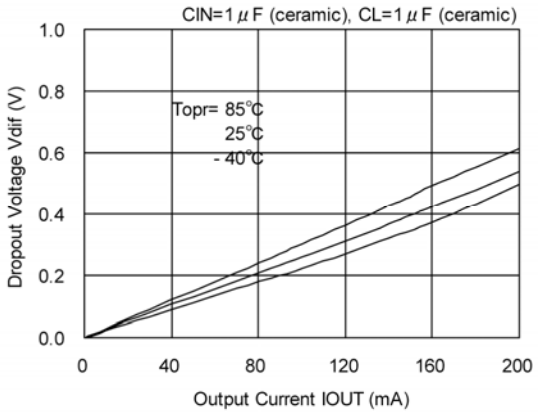
■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(3) Dropout Voltage vs. Output Current

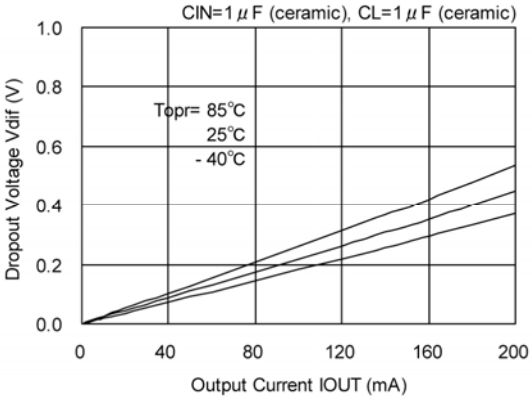
XC6219x182



XC6219x252

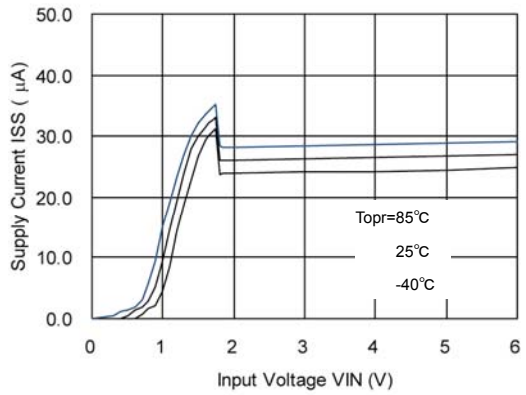


XC6219x302

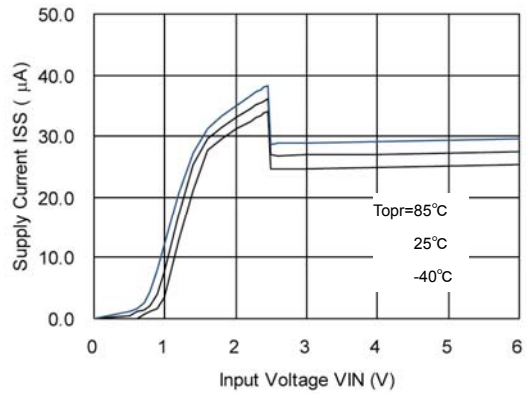


(4) Supply Current vs. Input Voltage

XC6219x182



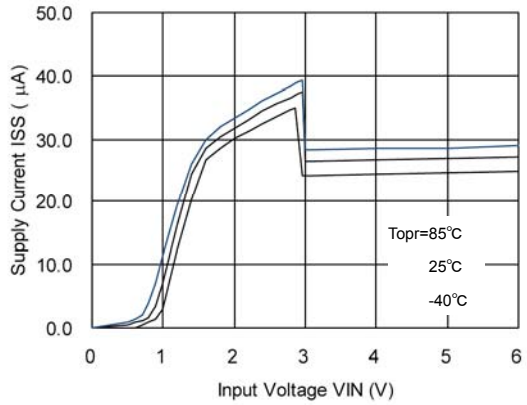
XC6219x252



■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

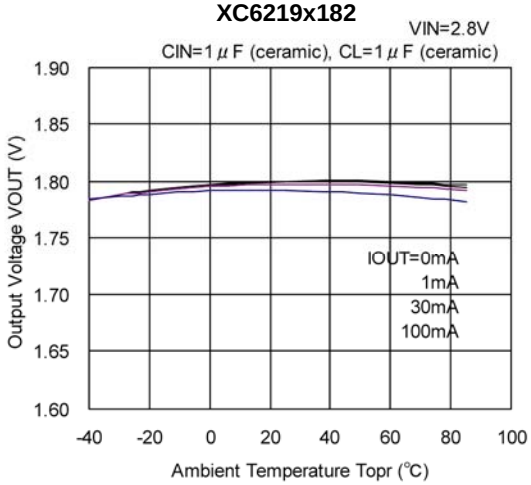
(4) Supply Current vs. Input Voltage (Continued)

XC6219x302

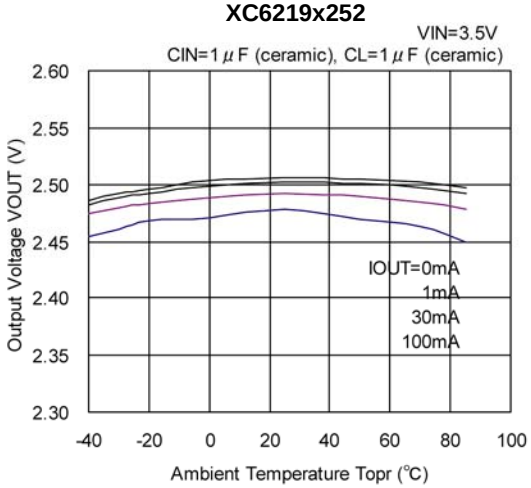


(5) Output Voltage vs. Ambient Temperature

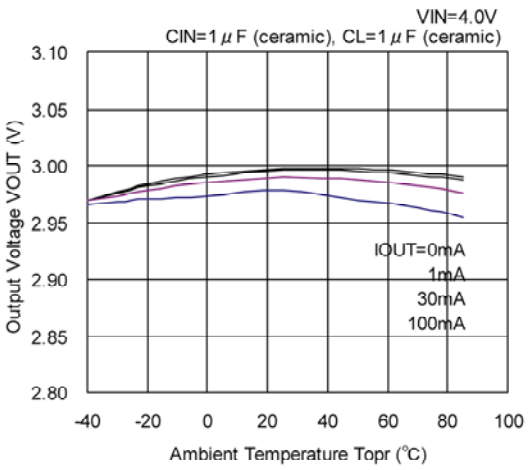
XC6219x182



XC6219x252



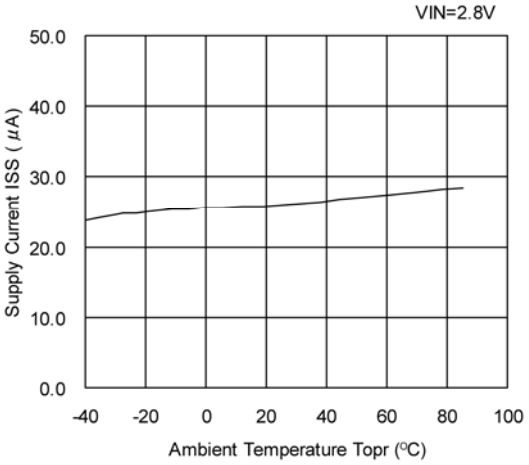
XC6219x302



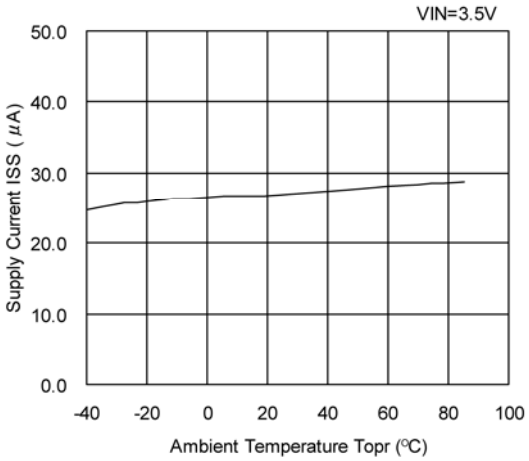
■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(6) Supply Current vs. Ambient Temperature

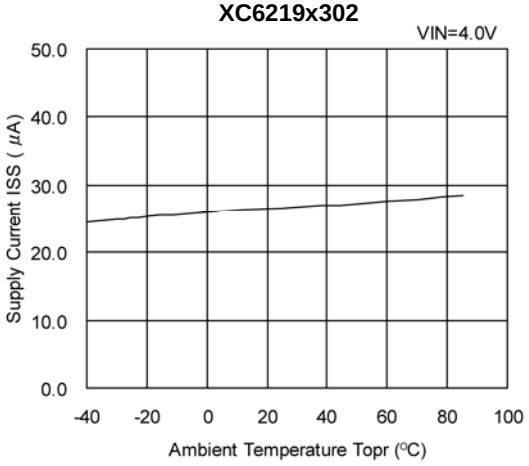
XC6219x182



XC6219x252



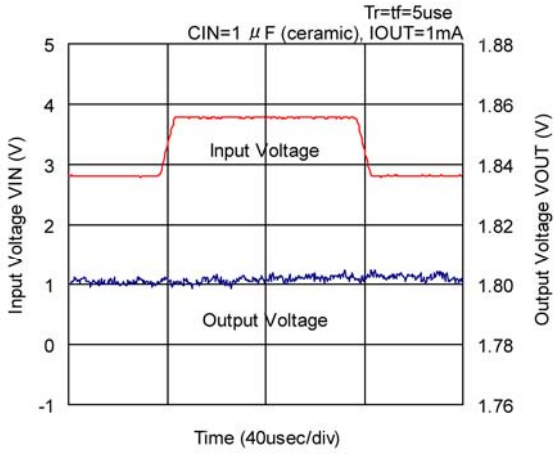
XC6219x302



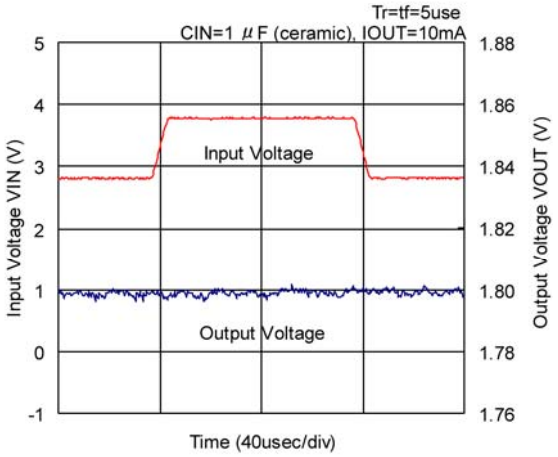
■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(7) Input Transient Response

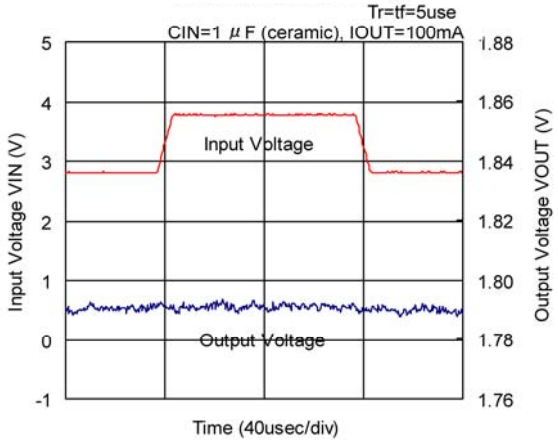
XC6219x182



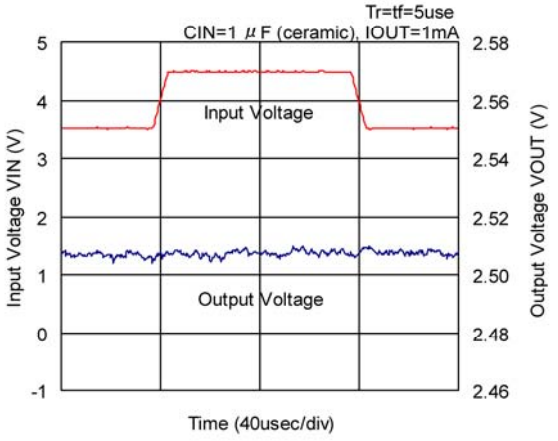
XC6219x182



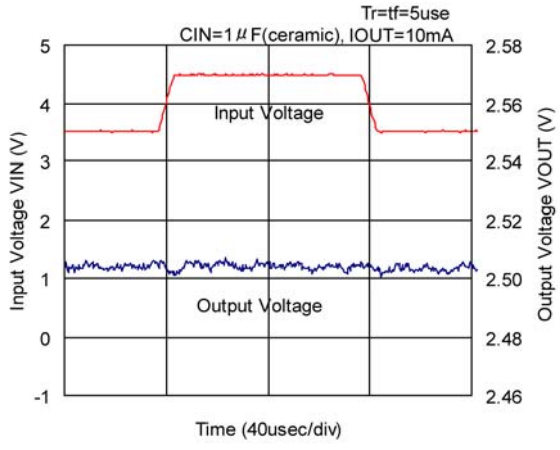
XC6219x182



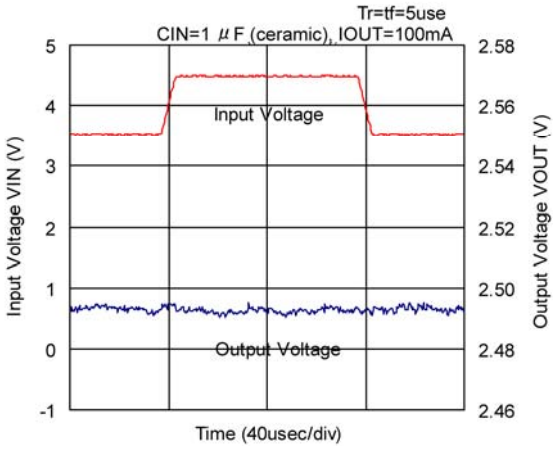
XC6219x252



XC6219x252



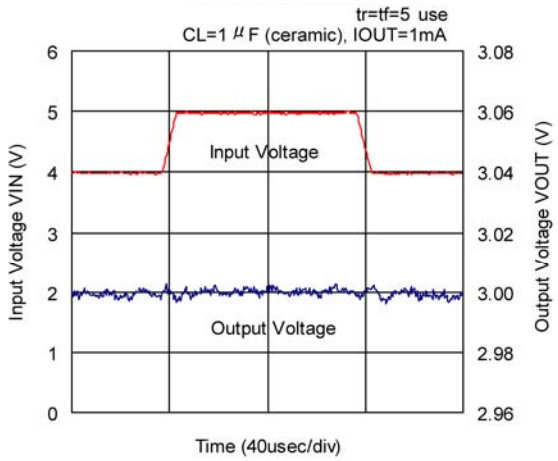
XC6219x252



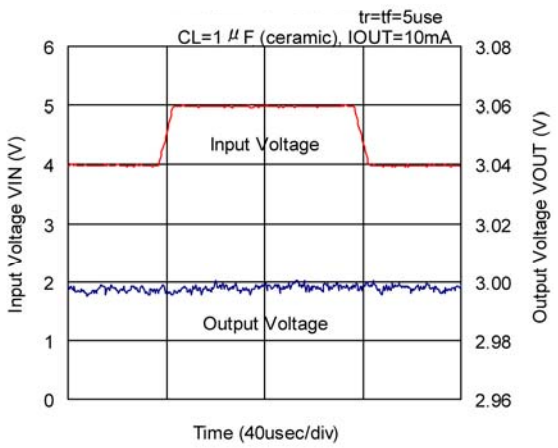
■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(7) Input Transient Response (Continued)

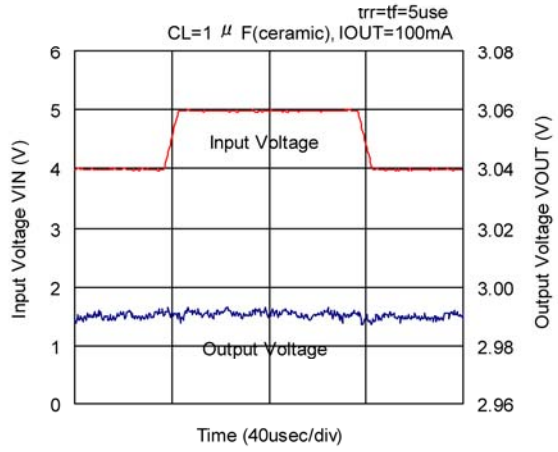
XC6219x302



XC6219x302

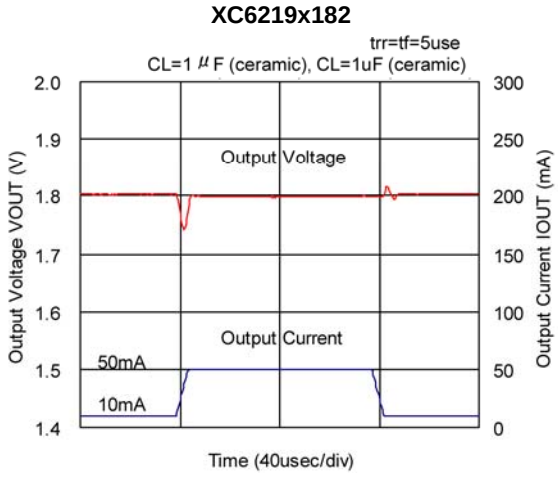


XC6219x302

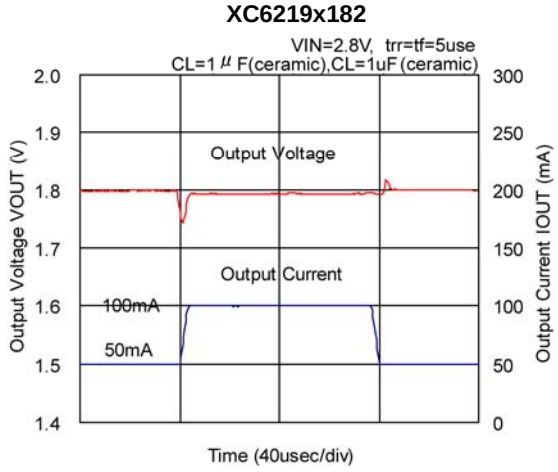


(8) Load Transient Response

XC6219x182



XC6219x182

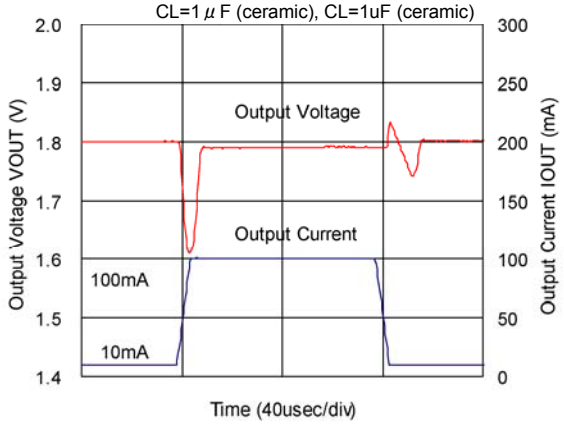


■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(8) Load Transient Response (Continued)

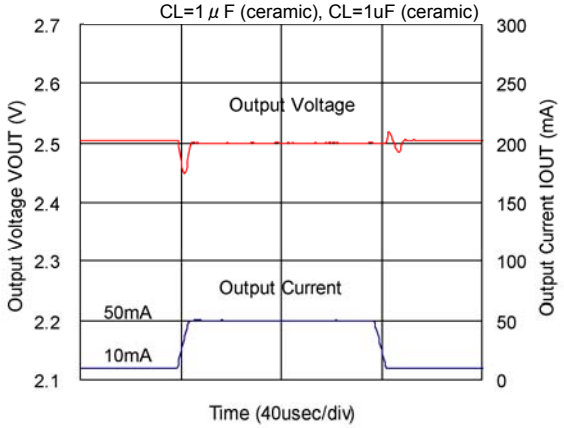
XC6219x182

VIN=2.8V, trr=tf=5use
CL=1μF (ceramic), CL=1uF (ceramic)



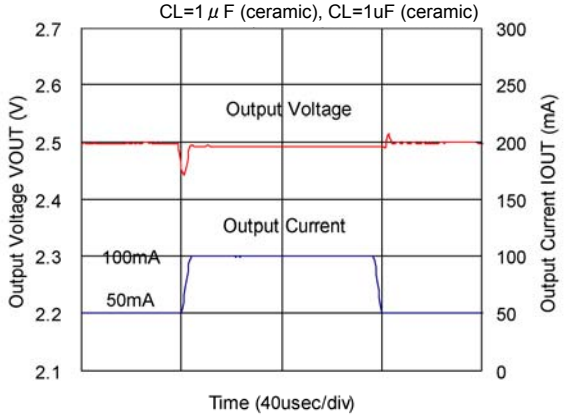
XC6219x252

VIN=3.5V, trr=tf=5use
CL=1μF (ceramic), CL=1uF (ceramic)



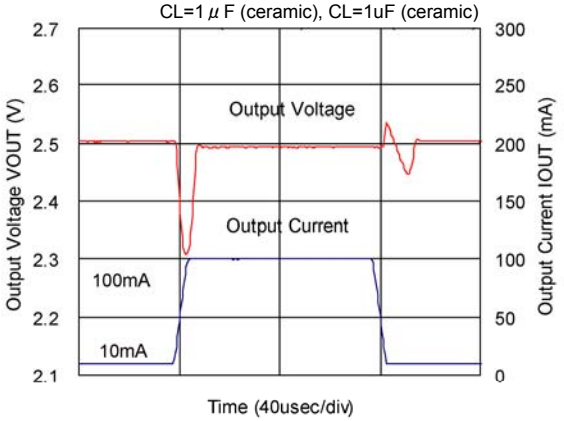
XC6219x252

VIN=3.5V, trr=tf=5use
CL=1μF (ceramic), CL=1uF (ceramic)



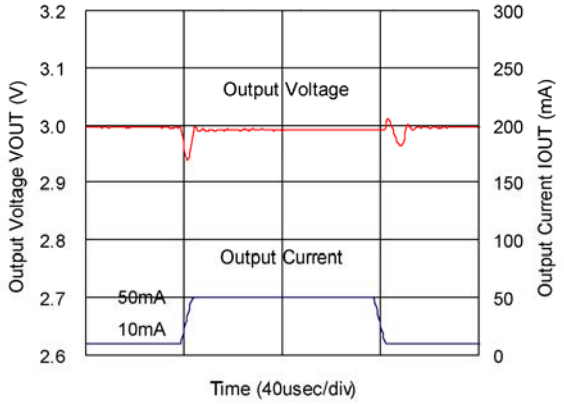
XC6219x252

VIN=3.5V, trr=tf=5use
CL=1μF (ceramic), CL=1uF (ceramic)



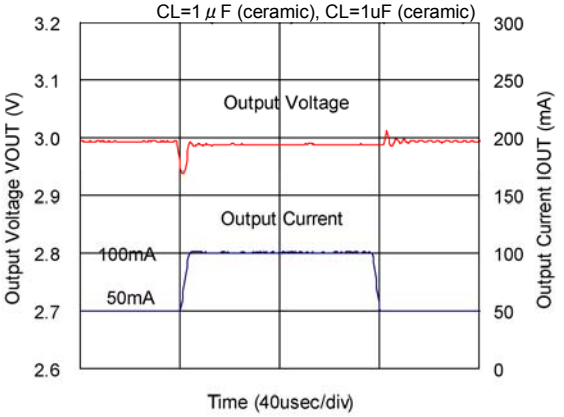
XC6219x302

VIN=4.0V, trr=tf=5use
CL=1μF (ceramic), CL=1uF (ceramic)



XC6219x302

VIN=4.0V, trr=tf=5use
CL=1μF (ceramic), CL=1uF (ceramic)

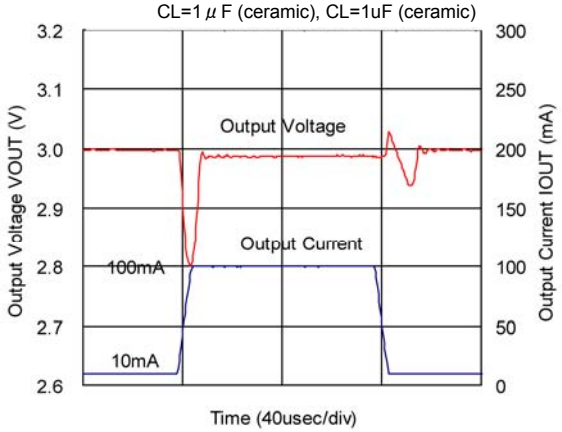


■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(8) Load Transient Response (Continued)

XC6219x302

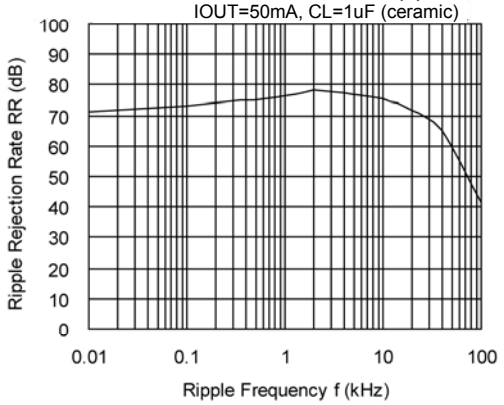
VIN=4.0V, trr=tf=5use
CL=1 μ F (ceramic), CL=1uF (ceramic)



(9) Ripple Rejection Rate

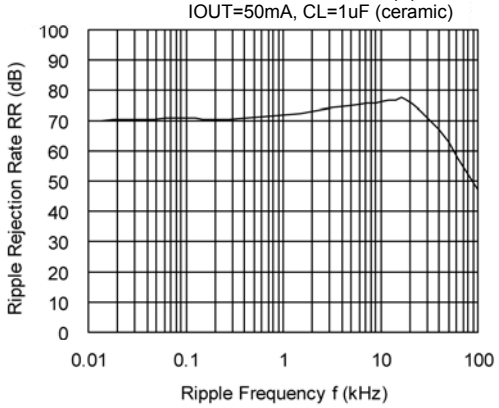
XC6219x182

VIN=2.8V, DC+1Vp-pAC
IOUT=50mA, CL=1uF (ceramic)



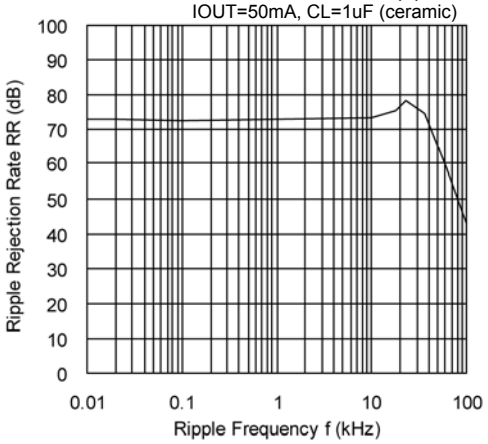
XC6219x252

VIN=3.5V, DC+1Vp-pAC
IOUT=50mA, CL=1uF (ceramic)



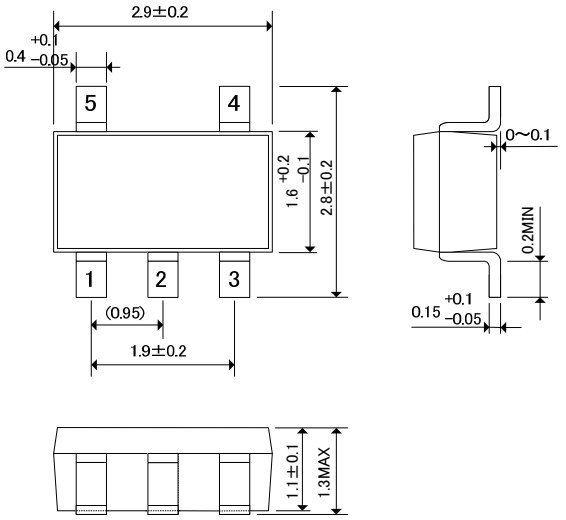
XC6219x302

VIN=4.0V, DC+1Vp-pAC
IOUT=50mA, CL=1uF (ceramic)

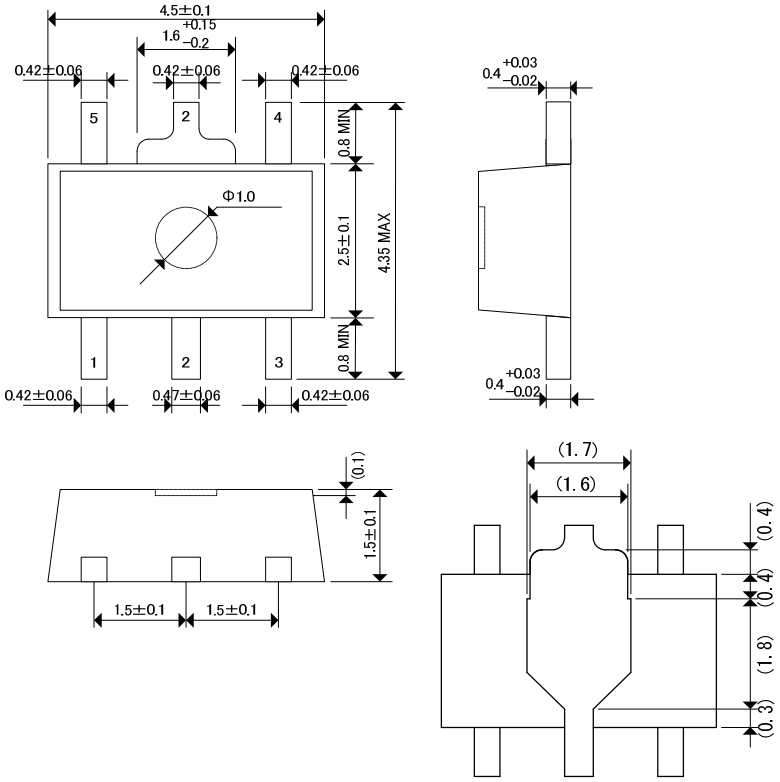


■PACKAGING INFORMATION

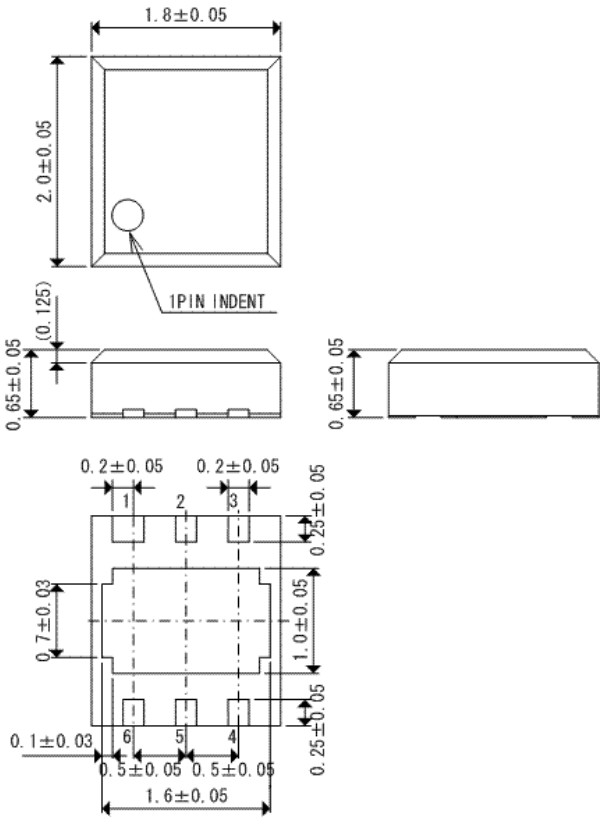
●SOT-25



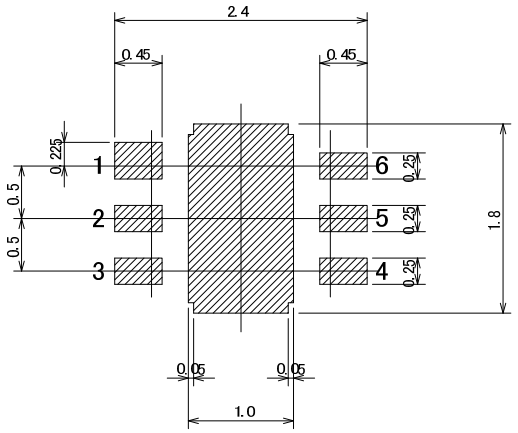
●SOT-89-5



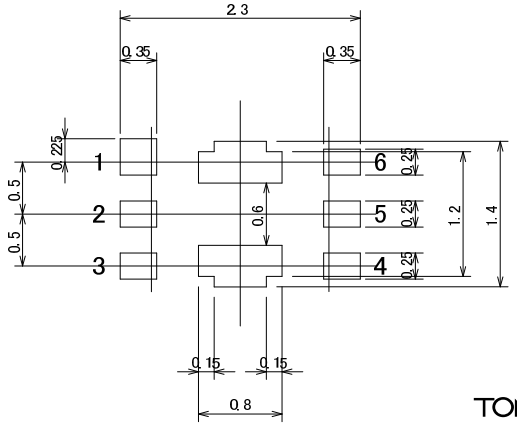
●USP-6B



●USP-6B Reference Pattern Layout



●USP-6B Reference Metal Mask Design

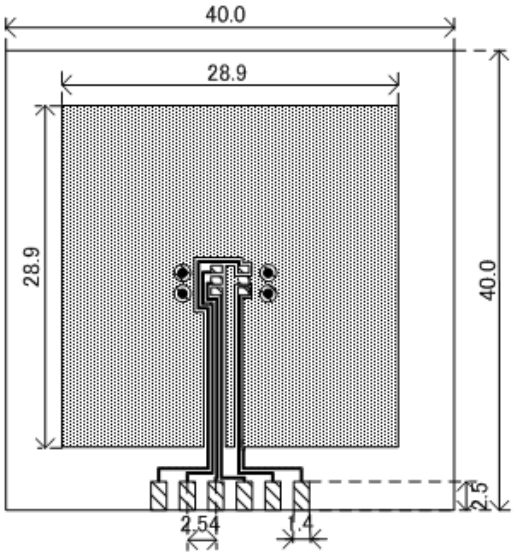


● SOT-25 Power Dissipation

Power dissipation data for the SOT-25 is shown in this page.
The value of power dissipation varies with the mount board conditions.
Please use this data as the reference data taken in the following condition.

1. Measurement Condition

Condition:	Mount on a board
Ambient:	Natural convection
Soldering:	Lead (Pb) free
Board Dimensions:	40 x 40 mm (1600 mm^2 in one side)
Metal Area :	Copper (Cu) traces occupy 50% of the board area in top and back faces. Package heat-sink is tied to the copper traces
Material:	Glass Epoxy (FR-4)
Thickness:	1.6 mm
Through-hole:	4 x 0.8 Diameter

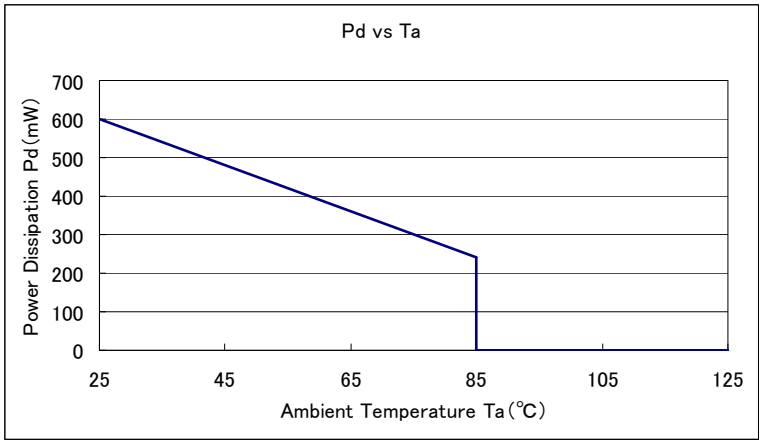


Evaluation Board (Unit: mm)

2. Power Dissipation vs. Ambient Temperature (85℃)

Board Mount (Tjmax=125℃)

Ambient Temperature (℃)	Power Dissipation Pd (mW)	Thermal Resistance (℃/W)
25	600	166.67
85	240	

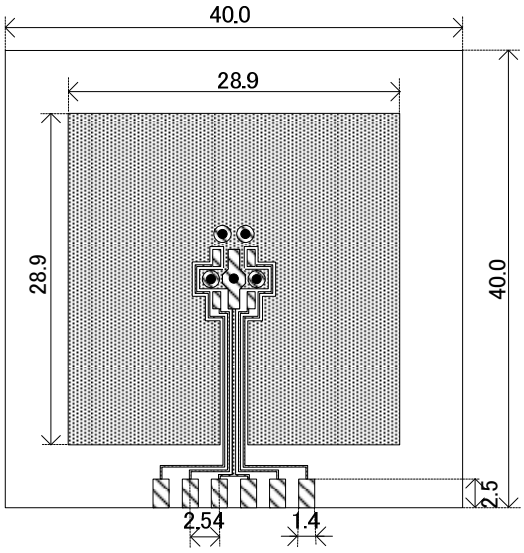


● SOT-89-5 Power Dissipation

Power dissipation data for the SOT-89-5 is shown in this page.
The value of power dissipation varies with the mount board conditions.
Please use this data as the reference data taken in the following condition.

1. Measurement Condition

Condition:	Mount on a board
Ambient:	Natural convection
Soldering:	Lead (Pb) free
Board Dimensions:	40 x 40 mm (1600 mm^2 in one side)
Metal Area :	Copper (Cu) traces occupy 50% of the board area in top and back faces. Package heat-sink is tied to the copper traces
Material:	Glass Epoxy (FR-4)
Thickness:	1.6 mm
Through-hole:	5 x 0.8 Diameter

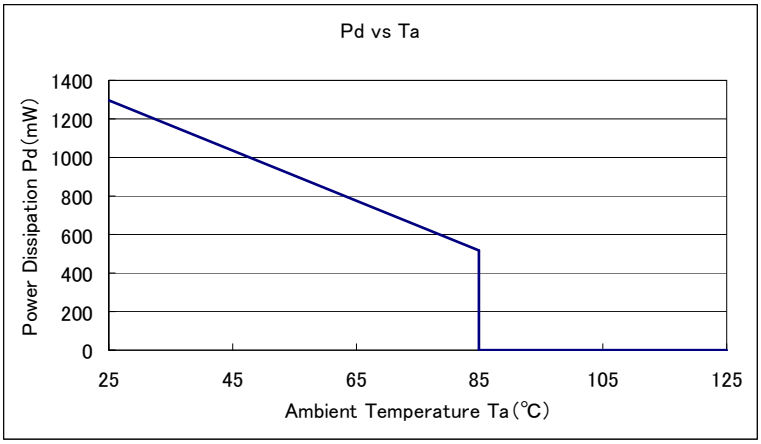


Evaluation Board (Unit: mm)

2. Power Dissipation vs. Ambient Temperature (85℃)

Board Mount (Tjmax=125℃)

Ambient Temperature (℃)	Power Dissipation Pd (mW)	Thermal Resistance (℃/W)
25	1300	76.92
85	520	

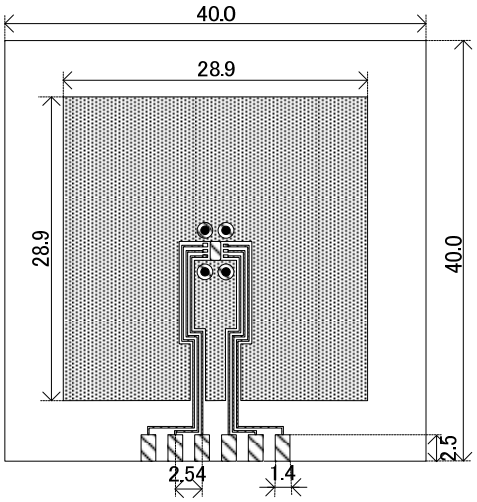


● USP-6B Power Dissipation

Power dissipation data for the USP-6B is shown in this page.
The value of power dissipation varies with the mount board conditions.
Please use this data as the reference data taken in the following condition.

1. Measurement Condition

Condition:	Mount on a board
Ambient:	Natural convection
Soldering:	Lead (Pb) free
Board Dimensions:	40 x 40 mm (1600 mm^2 in one side)
Metal Area:	Copper (Cu) traces occupy 50% of the board area in top and back faces. Package heat-sink is tied to the copper traces
Material:	Glass Epoxy (FR-4)
Thickness:	1.6 mm
Through-hole:	4 x 0.8 Diameter

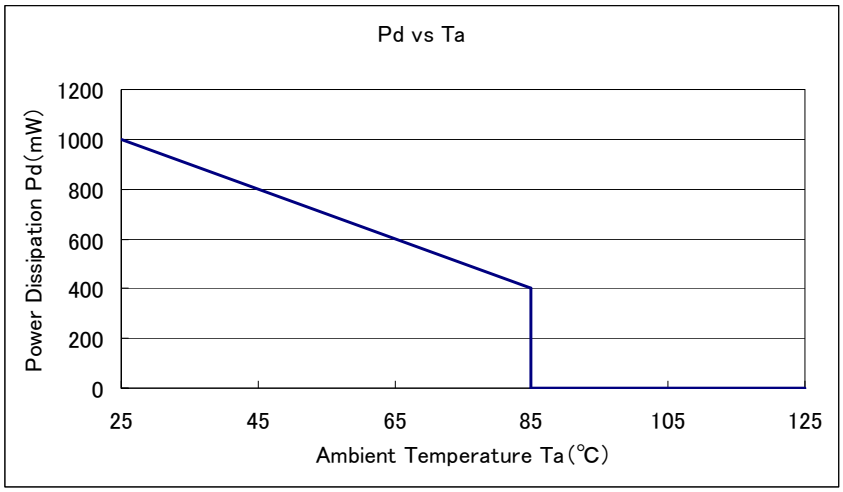


Evaluation Board (Unit: mm)

2. Power Dissipation vs. Ambient Temperature

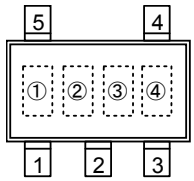
Board Mount (Tj max = 125℃)

Ambient Temperature（℃）	Power Dissipation Pd（mW）	Thermal Resistance(℃/W)
25	1000	100.00
85	400	

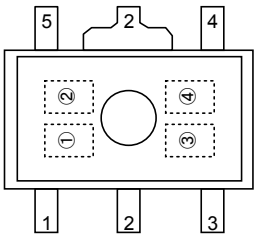


■MARKING RULE

●SOT-25, SOT-89-5



SOT-25
(TOP VIEW)



SOT-89-5
(TOP VIEW)

① represents product series

MARK	PRODUCT SERIES
L	XC6219xxxxxx

② represents type of regulator

MARK				PRODUCT SERIES
V_{OUT} 100mV INCREMENTS		V_{OUT} 50mV INCREMENTS		
V_{OUT}:0.1~3.0V	V_{OUT}:3.1~6.0V	V_{OUT}:0.15~3.05V	V_{OUT}:3.15~6.05V	
V	A	E	L	XC6219Axxxxx
X	B	F	M	XC6219Bxxxxx
Y	C	H	N	XC6219Cxxxxx
Z	D	K	P	XC6219Dxxxxx
V	A	E	L	XC6219Exxxxx
X	B	F	M	XC6219Fxxxxx
Y	C	H	N	XC6219Gxxxxx
Z	D	K	P	XC6219Hxxxxx

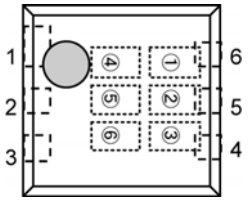
③ represents output voltage

MARK	OUTPUT VOLTAGE (V)				MARK	OUTPUT VOLTAGE (V)			
0	-	3.1	-	3.15	F	1.6	4.6	1.65	4.65
1	-	3.2	-	3.25	H	1.7	4.7	1.75	4.75
2	-	3.3	-	3.35	K	1.8	4.8	1.85	4.85
3	-	3.4	-	3.45	L	1.9	4.9	1.95	4.95
4	-	3.5	-	3.55	M	2.0	5.0	2.05	-
5	-	3.6	-	3.65	N	2.1	-	2.15	-
6	-	3.7	-	3.75	P	2.2	-	2.25	-
7	-	3.8	-	3.85	R	2.3	-	2.35	-
8	0.9	3.9	0.95	3.95	S	2.4	-	2.45	-
9	1.0	4.0	1.05	4.05	T	2.5	-	2.55	-
A	1.1	4.1	1.15	4.15	U	2.6	-	2.65	-
B	1.2	4.2	1.25	4.25	V	2.7	-	2.75	-
C	1.3	4.3	1.35	4.35	X	2.8	-	2.85	-
D	1.4	4.4	1.45	4.45	Y	2.9	-	2.95	-
E	1.5	4.5	1.55	4.55	Z	3.0	-	3.05	-

④ represents production lot number
0 to 9, A to Z reverse character of 0 to 9, A to Z repeated (G, I, J, O, Q, W excluded)

■MARKING RULE (Continued)

●USP-6B



USP-6B
(TOP VIEW)

①② represents product series

MARK		PRODUCT SERIES
①	②	
1	9	XC6219xxxxDx

③ represents type of regulator

MARK	TYPE	PRODUCT SERIES
A	High Active, pull-down resistor built-in (semi-custom)	XC6219AxxxMx
B	High Active, no pull-down resistor built-in (standard)	XC6219BxxxMx
C	Low Active, pull-up resistor built-in (semi-custom)	XC6219CxxxMx
D	Low Active, no pull-up resistor built-in (semi-custom)	XC6219DxxxMx
E	High Active, pull-down resistor built-in (semi-custom)	XC6219ExxxDx
F	High Active, no pull-down resistor built-in (standard)	XC6219FxxxDx
Z	Low Active, pull-up resistor built-in (semi-custom)	XC6219GxxxDx
H	Low Active, no pull-up resistor built-in (semi-custom)	XC6219HxxxDx

④ represents product series

MARK	VOLTAGE (V)	PRODUCT SERIES
3	3.X	XC6219x3xxDx
5	5.X	XC6219x5xxDx

⑤ represents output voltage

MARK	VOLTAGE	PRODUCT SERIES	SYMBOL	VOLTAGE	PRODUCT SERIES
0	X.0	XC6219xx0xDx	A	X.05	XC6219xx0ADx
1	X.1	XC6219xx1xDx	B	X.15	XC6219xx1ADx
2	X.2	XC6219xx2xDx	C	X.25	XC6219xx2ADx
3	X.3	XC6219xx3xDx	D	X.35	XC6219xx3ADx
4	X.4	XC6219xx4xDx	E	X.45	XC6219xx4ADx
5	X.5	XC6219xx5xDx	F	X.55	XC6219xx5ADx
6	X.6	XC6219xx6xDx	H	X.65	XC6219xx6ADx
7	X.7	XC6219xx7xDx	K	X.75	XC6219xx7ADx
8	X.8	XC6219xx8xDx	L	X.85	XC6219xx8ADx
9	X.9	XC6219xx9xDx	M	X.95	XC6219xx9ADx

⑥ represents production lot number
0 to 9, A to Z repeated (G, I, J, O, Q, W excluded)
* No character inversion used.

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4. The products in this datasheet are not developed, designed, or approved for use with such equipment whose failure of malfunction can be reasonably expected to directly endanger the life of, or cause significant injury to, the user.
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